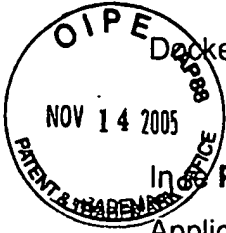


AP/CFW



Docket No. TIP484US

TI-36211

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In **PATENT** application of:

Applicant: Rajesh Tiwari et al.
Application No.: 10/663,948
For: DUAL DEPTH TRENCH TERMINATION METHOD FOR
IMPROVING CU-BASED INTERCONNECT INTEGRITY
Filing Date: September 16, 2003
Examiner: Phat X. CAO
Art Unit: 2814

REPLY TO OFFICE ACTION DATED SEPTEMBER 9, 2005

Mail Stop AF
Assistant Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Favorable reconsideration of the above-identified application is respectfully requested in view of the following amendments and remarks.

PC
11/22/05